CVD GROWTH and CHARACTERIZATION OF 2D TRANSITION METAL DICHALCOGENIDES, MoS₂ and WS₂

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ABSTRACT

Two-dimensional transition metal dichalcogenides (TMDC), specifically molybdenum disulfide and tungsten disulfide have received significant attention as their direct bandgap exhibits a shift from indirect to direct as the layer goes to single molecular thickness (2D). Hence, they have high potential to pave way for novel optoelectronic devices. However, their structural and optical properties are still not completely understood, especially, spatial change of photoluminescence intensities, variations in excitons-trions, and shift in peak wavelengths in these 2D flake structures need further investigation. In this research, after growing TMDCs using chemical vapor deposition technique, in addition to measuring micro Raman and photoluminescence spectra, we performed dark field microscopy measurements and photoluminescence mappings to identify grain boundaries and seeding particles. The results clearly show that the flakes, which look single-piece through the optical spectroscopy images, in fact, include grain boundaries, seeds and wrinkles. Photoluminescence maps reveal that emission occurs due to different mechanisms such as excitons and trions, depending on the locations on the flakes where the measurement is performed. Our results show that there are different routes that emission can occur and 2D TMDCs provide a rich variety of alternatives to realize novel photonic devices.

Keywords: MoS₂, WS₂, Two-dimensional materials, Chemical vapor deposition, Photoluminescence

1. INTRODUCTION

For high-performance optoelectronic devices and systems, realizing materials with high quantum efficiency is crucial for them to be used in different fields including defense industry, optical communications, security, medical applications and advanced technological applications. Currently, different material systems such as GaN, GaAlAs, InGaAs, InGaAsSb are already being used emphasizing their high quantum yield characteristics in the related technology. On the other hand, optoelectronics market share and its usage areas are continuously increasing with higher performance expectations such as superior efficiency, wider spectral range, flexibility, transparency, less material consumption and CMOS integration [1]. To reach these objectives, the drawbacks of the conventional materials, such as that of Si or GaAs based materials, should be overcome. Novel systems are needed to be developed and innovative structures are required to enhance the overall performance criteria. For novel breakthroughs in this area, it is expected that 2 dimensional (2D) material systems have a potential to provide the key technology. In this research, we have grown and characterized 2D MoS₂ and WS₂, transition metal dichalcogenides (TMDCs). These materials have potential not only be used in optoelectronic devices but also pave the way for other innovative electronic systems with increased performance and functionality [2]. Additionally, with the successful deposition of these 2D TMDCs, it will be possible to discover their excitonic properties such as losses in carrier transport and exciton life time.

When a material makes a transition from its bulk form into other dimensions, the material characteristics is found to change fundamentally, which points out to a high potential to realize novel devices with extra-ordinary properties [3, 4]. Two-dimensional (2D) materials were first realized with the exfoliation of graphene from graphite in 2004, where this new material showed very high electron mobility,
mechanical strength, high thermal conductivity and flexibility [5-8]. After this discovery, it is suggested that there are about 500 2D materials that are waiting to be found [9]. However, there are still major issues for such 2D materials to transit from laboratories to manufacturing, firstly due to difficulties in large area-growth [10]. For the case of graphene, specifically, it has the zero bandgap, which makes it difficult to build a device without losing the material’s superior properties. Hence, there is an ongoing effort of discovering novel 2D material systems rather with a direct bandgap that can be utilized optoelectronics, microelectronics and energy applications. Within this context, TMDCs, MX₂ (M=Mo, W; X=S, Se, Te), have started to be studied widely in the recent years [11-14]. Their potential has been shown in optoelectronics [15], valleytronics [16], catalysis [17], microelectronics [18] and batteries [19]. Among these TMDCs, 2D WS₂ has also appealed a special attention both in electronics and photonics [20]. Semiconductor TMDCs are found to possess a direct bandgap when they become single-layered [21]. Hence, both MoS₂ and WS₂ have direct optical bandgaps, high photoluminescence and additionally very interesting excitonic properties in their heterostructures [22]. For these TMDCs also, scalable, high-quality, large-area growth is still a matter of research [17, 23]. Mechanical exfoliation, chronically the first method in history, is not suitable for large area commercial applications. Similarly, it is not easy to use the methods including ionic intercalation and liquid exfoliation for industry [24, 25]. In this respect, chemical vapor deposition (CVD) presents a high potential to realize large-area and single-layer films [17, 23, 26-28]. Although the principal growth mechanism is still not understood fully, up to present promising results are achieved using CVD [29-33]. In this research study, we utilized CVD to obtain 2D MoS₂ and WS₂ flakes where with CVD growth parameters, we could control the grown films. We characterized our flakes by using micro Raman, photoluminescence (PL) spectra. Monolayer MoS₂ and monolayer WS₂ have exciton binding energies of ~0.9 eV and ~0.5 eV, respectively where exciton (two charge carriers), trions (three charge carriers) and biexcitons (four charge carriers) can occur due to this strong Coulombic interaction [34]. Hence, in this research, we studied change in PL intensities and peak wavelengths spatially.

2. EXPERIMENTAL

Figure 1 shows the experimental setup of the CVD system schematically; the CVD reaction chamber with a movable heating zone is specifically designed to grow 2D materials to achieve both fast cooling and multi temperature zones for different precursors. The quartz boats contain high purity S powder (99.5%, Alfa) and MoO₃/WO₃ (99.9%, Sigma-Aldrich). MoO₃ and WO₃ precursors are used to grow MoS₂ and WS₂, respectively. These precursors are positioned at different temperature zones, which are identified with respect to their melting temperatures, ~820°C for WO₃, ~700°C for MoO₃ and 150°C for sulfur. In the case of MoS₂ flake growth, 150 mg Sulphur and 1.5 mg MoO₃ powder are used as precursors and likewise, for the case of WS₂, 150 mg S and 1.5 mg WO₃ powder are used. Table 1 lists the process parameters optimized for 2D MoS₂ and WS₂. Since radical vapor ratios are critical to obtain mono-layer formation, substrate temperature and their spatial locations are carefully adjusted. These parameters have been studied in our previous studies [32, 33]. D₈ indicates the distance between boats of MoO₃ or WO₃ powder and the substrates in horizontal growth configuration; Tₛ indicates the temperature of the substrate.

In addition to the planar growth, it is also possible to use face-down growth configuration as presented in the inset of Figure 1. In this configuration, MoO₃ powder is placed in a quartz cylinder that has a height and a diameter of 2 cm. The 2 cm² Si/SiO₂ substrate is placed on this cylinder and MoS₂ is formed on the downward facet of the substrate at 700 °C by using 400 sccm N₂ under atmospheric pressure. As shown in the inset of Figure 1, there is a 2 cm vertical difference between the position of the precursor and the substrate where the substrate is placed on the quartz boat. In our experiments, we used planar configuration for 2D WS₂ growth and face-down configuration for 2D MOS₂ growth.
Regarding the deposition, just before process starts, the SiO\(_2\) (~300 nm) coated Si substrates are cleaned by piranha etch solution and RCA technique. The temperature of reaction chamber is increased at a rate of 15°C/min using nitrogen gas. For the case of WS\(_2\) growth, H\(_2\) is also introduced to the system as a carrying gas to promote 2D formations. H\(_2\) is reported to enhance the size and density of crystals due to the increased reduction of WO\(_3\), however, excessive amount is stated to cause the grown WS\(_2\) films to be etched [35]. Hence, in this research, 5% of H\(_2\) is an optimized value for favoring the 2D WS\(_2\) growth. The distance between the precursors of sulphur and MoO\(_3\)/WO\(_3\) is kept at 16 cm but the furnace is pulled 4 cm towards the sulphur powder to increase the sulphur vapor pressure as the growth temperature is reached.

![Figure 1](image.png)

**Figure 1.** (a) The experimental setup of the CVD designed specifically for 2D TMDC growth with horizontal configuration. Substrate holder for the case of face-down growth is shown in the inset

<table>
<thead>
<tr>
<th></th>
<th>Ts (°C)</th>
<th>Ds (cm)</th>
<th>Growth duration (minutes)</th>
<th>N(_2) – Flow rate (sccm)</th>
<th>H(_2) - Flow rate (sccm)</th>
<th>Pressure</th>
</tr>
</thead>
<tbody>
<tr>
<td>MoS(_2)</td>
<td>data</td>
<td>(face-down)</td>
<td>3</td>
<td>400</td>
<td>-</td>
<td>ambient</td>
</tr>
<tr>
<td>WS(_2)</td>
<td>820</td>
<td>1.5</td>
<td>3</td>
<td>380</td>
<td>20</td>
<td>ambient</td>
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When the deposition temperature is reached, S vapor reduces MoO\(_3\)/WO\(_3\) powder to volatile suboxides producing intermediate products such as MoO\(_2\) and WO\(_2\) [36] and the formed radicals diffuse on the substrate reacting with sulfur and monolayers are realized by the equations (1-2) and (3-4), for MoS\(_2\) and WS\(_2\), respectively [23, 37]. In general, precursor ratio (in fact, the dissociated radicals’ ratio) is suggested to be the essential internal parameter determining the monolayer formation. The optimal sulfurization process can be completed by controlling this ratio carefully. As the deposition duration is finished, a rapid cooling down process needs to be carried out to avoid other products such as MoO\(_3\) and multi layer growth of MoS\(_2\) where 500 sccm of nitrogen gas (99.999%) is purged in the tube.
MoO$_3$ + (x/2) S → MoO$_{3-x}$ + (x/2) SO$_2$  \hspace{1cm} (1)

MoO$_{3-x}$ + (7-x)/2 S → MoS$_2$ + (3-x)/2 SO$_2$  \hspace{1cm} (2)

7S + 2WO$_3$ → 2WS$_2$ + 3SO$_2$  \hspace{1cm} (3)

WO$_3$ + 3S + H$_2$ → WS$_2$ + SO$_2$ + H$_2$O  \hspace{1cm} (4)

We carried out Raman and PL spectral characterizations with Witec α-300 R µ-Raman system at room temperature where we used 532 nm excitation wavelength for both Raman and PL measurements. We obtained the images of the flakes by confocal optical microscopy and differential interference contrast (DIC) microscopy with Nikon Eclipse LV100NDA microscope. DIC is utilized to enhance the contrast in our monolayers, which are inherently transparent. The technique is based on the principle of interferometry providing the optical path length of the sample allowing us to see the features such as grain boundaries, which are otherwise invisible [38].

3. RESULTS and DISCUSSION

Figure 2 (a) shows the images of the MoS$_2$ flake images obtained measured by confocal optical microscopy. As a result of the described growth procedure, flakes with a side of 40 µm are formed. In this growth scheme, we observe that flakes touch, overlap or merge to form larger. In general, with this configuration, we obtain flakes that are radially distributed over the substrate. Center of the substrate contains rather smaller flakes whereas these flakes get larger when we get closer to the edges of the substrate. The size of the flakes can be adjusted by changing the duration of positioning the furnace to the left hand side (onto the sulphur) when the growth zone reaches 700 °C. This change in flake size is attributed to the slower sulfurization process. It is reported that the film formation occurs in TMDCs by the growth of individual flakes and their coalescence or merging [39, 40]. Therefore, some extra growth time initiate a slower growth process (little S vapor can reach the substrate) and the flakes grow larger till they merge to form a continuous monolayer film.

The designated region with a red rectangle on the image region is also investigated by dark field optical microscopy (Figure 2 (b)). Grain-boundary structure, which is not visible by optical microscopy but visible in the dark field optical images in Figure 2 (b) suggests that the flakes are not epitaxially connected but rather overlapped. This can be attributed to the amorphous SiO$_2$ layer that does not support van der Waals epitaxy as lattice matched c-Al$_2$O$_3$ and GaN would provide [41, 42]. The orange arrows point out to the boundaries inside the flake (rather straight lines) and the green arrow indicates the seed. For the MoS$_2$ flakes to grow these seeds are needed, hence a large number of seed cause smaller flakes.

Figure 2 (c) shows the Raman scattering spectra between 360 and 430 cm$^{-1}$. MoS$_2$ has two characteristic Raman peaks corresponding to in-plane vibration of Mo and S atoms (E$^{1g}_{2g}$) at 383 cm$^{-1}$ and the out-of-plane vibration of S atoms (A$^{1g}_{1g}$) at 408 cm$^{-1}$ where the change in difference between these two peaks is used as an indicator for the number of layers [41]. When the layers decrease, the mode at 383 cm$^{-1}$ shifts to the lower frequencies and the mode at 408 cm$^{-1}$ shifts to higher frequencies, [22, 39], resulting in closer positioned peaks. Figure 2 (d) presents delta Raman mapping image (difference between A$_{1g}$ and E$^{1g}_{2g}$ peak positions). Raman single spectra in Figure 2 (c) are taken from the points shown by the arrows on this map (red: P1 and green P2). Boundaries inside the flakes indicated by orange arrows in Figure 2 (b) point to the existence of structural defects (line defects). SNOM-PL-analysis and SEM investigation
of butterfly like flakes reveal 20 nm wide line defects inside the flake [43]. These line defects are labeled as grain-boundaries inside the flake due to the growth nature of the butterfly shape where more than one flake seem to merge [43]. However, in our case, the line defects demonstrated in Figure 2 (b) inside the single flake are hardly found to be the grain-boundary but more likely to be the defects related to the stress effect [44]. On the other hand, green arrow pointing the brighter dot indicates the seed initiating the growth of the flakes [45]. Despite the overlapped regions, flakes that have no contact with their neighbor are monolayers. This can be evidenced from the Figure 2 (c). In general, this difference depends on the preparation method of the MoS₂ flakes. For example, mechanically exfoliated MoS₂ flakes have 18 cm⁻¹ Raman peak difference [46]. On the other hand, the difference in CVD grown flakes might have higher values such as 22 cm⁻¹ for a single-layer flake [47], which agrees with our delta map. In our delta map, in general, we observe a delta of ~ 22 cm⁻¹ as shown in Figure 2 (c). Maximum peak difference is observed in those reddish data and they never exceed above 22.2 cm⁻¹ as demonstrated in Figure 2(d).

![Image](image_url)

**Figure 2.** a) Confocal optical image of MoS₂ flakes. Analyzed region is demonstrated with a red rectangle on the image b) Dark field optical microscope image of MoS₂. Orange arrows point straight lines inside the flake and green arrow points the seed c) Raman scattering spectra d) delta Raman mapping image (difference between E₁²g and A₁g peaks); the points demonstrated by arrows on the map are the positions where Raman spectra is measured.
Realization of indirect to direct electronic band gap transition and the resulting high-intensity PL has appealed substantial attention to study optical properties of such large-area monolayers aiming for novel photonic devices [48]. Figure 3 exhibits the photoluminescence properties of the grown MoS$_2$ monolayers. 45x45 µm$^2$ area with 150 x150 data points (22500 data points in total) are scanned with a 532 nm laser, 1 mW laser power and 1 second integration time. Figure 3(a) demonstrates the total PL intensity map. It is obtained by calculating the total area under the PL curve for each data points. Since the value of the area is not a convenient measure to construct a colored scale bar, the total PL intensity is normalized according maximum area value to get a normalized total intensity map. Red zones in this map therefore, demonstrates the regions where maximum PL intensity is obtained. From the figure, it is seen that the PL intensity is not fully uniform where PL intensity reduces at rather sharp edges of the triangular flake.

Figure 3. a) Integrated and normalized total PL intensity b) single spectrum of a random point taken from the flake and the fitted curves c) B exciton peak center map d) A exciton peak center map e) Trion peak center map

PL spectrum in Figure 3(b) can be deconvoluted into three Lorentzian peaks similar to the cases studied in different reports [49-51]. These deconvoluted peaks can be further be used to study the PL phenomena in these materials. Physical interpretation of different peaks is related with the exciton and trion generation and recombination. The B exciton peak between 627 nm to 632 nm (Figure 2(c)), A exciton peak between 675 nm to 678 nm (Figure 3(d)), and trion (A') peak between 680 nm and 685 nm (Figure 3(d)) are mapped for the same flake. Different energy levels of A and B peaks are attributed to the valance band splitting at K point due to the strong spin-orbit coupling inherent to the TMDC materials. It is interesting to note that the PL peak center of the A, B and A' shifts according to flake position, which accompanies with the intensity variation. By using the intensity data of the A and A' from the fitted curves, we may map the major photoluminescence mechanism. In order to accomplish this, the
The intensity ratio of the A and A' is calculated and the resulting map image is demonstrated in Figure 4. The map depicts that the majority of the edges are slightly dominated by the trion PL mechanism (A/A' is just below 1). A small fraction at the center zone (where possibly the seed resides) is dominated by the A exciton.

Figure 4. Map of intensity ratio of A exciton to trion luminescence

Figure 5 (a) shows optical microscopy images of 2D WS₂ flakes. In Figure 5(b) the same region is presented by the DIC microscopy where grain-boundaries are more visible similar to the MoS₂ case. Likewise the WS₂ flakes are overlapped. Also, for the WS₂ flakes, seeds are located at the center of the flakes, which indicates that for large and uniform film growth, these seeds need to be carefully controlled.

Figure 5 (c) shows the Raman scattering spectra between 280 and 380 cm⁻¹. Presented Raman modes in Figure 5(c) are in agreement with the previously reported main Raman peaks, which are E²_G(Γ) and A₁_G(Γ) at ~350 cm⁻¹ and ~415 cm⁻¹ respectively. It is stated that 62.2 cm⁻¹ frequency difference between these two peaks is accepted as an indicator of monolayer WS₂ structure at 532 nm laser excitation wavelength [52, 53]. In addition to that, as it is reported by some studies, the peak between ~295 cm⁻¹ and ~325 cm⁻¹ which is at ~310 cm⁻¹ tends to disappear when WS₂ transits from a few layers to a monolayer[54], which is also the case for our as–grown WS₂ flakes are monolayers.
Figure 5. a) Confocal optical image of WS$_2$ flakes b) the same region shown by dark field optical microscopy c) Raman scattering spectra

To have further understanding of the optical and structural properties of WS$_2$ formations, one of the flakes of which the optical microscopy image is shown in Figure 6 (a) is investigated through its photoluminescence properties. Figure 6 (b) shows the PL spectra with its deconvoluted peaks; the exciton peak at ~637 nm and trion peak at ~650 nm [34, 55]. In Figure 6 (c), maximum PL intensity map contains dark regions where we do not observe PL. These dark regions are suggested to be the seeds. Although for the 2D TMDC formation these seeds are needed, under our growth conditions, the seeding process continues after the flake is grown, which causes multi-layer film growth. Hence, PL intensity mapping also provides us to clarify the homogeneity of the flakes which is not possible by only confocal optical microscopy. In addition to these seeds and partial multi-layered structure of the flake, there is shift in the PL central wavelength as shown in Figure 6 (d). This result shows that luminescence is due to trion emission at the edges whereas excitonic emission is more profound at the interior regions of the flake.
4. CONCLUSIONS

By using the CVD technique, we obtained MoS$_2$ and WS$_2$ monolayers larger than 30 µm. These results confirm that CVD is a powerful technique to control and tune the properties of the monolayer flakes. Since the structural and optical characteristic of these TMDC material systems is a matter of research, we first measured µRaman and photoluminescence spectra and we performed dark field microscopy measurements together with photoluminescence mappings so that grain boundaries and seeding particles could be identified. Detailed analysis of PL spectra maps reveal that emission occurs due to different mechanisms such as excitons and trions where the dominant mechanism differs depending on the spatial locations of the flakes. DIC images are also in agreement with the PL maps regarding the grain boundaries and seeds exposing that dark field imaging can be used a rapid and reliable technique for such an analysis.

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